

Amendments to the Claims:

The following claims will replace all prior versions of the claims in this application (in the unlikely event that no claims follow herein, the previously pending claims will remain):

1. (Currently amended) Process for producing ~~by a molded structure of a polyamide layer and a polyolefin layer, comprising~~ blow-moulding a multilayer film containing at least a branched polyamide layer and a polyolefin layer, said polyolefin layer consisting essentially of polypropylene or LLDPE containing at most 5% of another polyethylene, characterized in that a branched polyamide is used as polyamide.

2-4. (Cancelled)

5. (Currently amended) Multilayer film containing at least a polyamide layer and a polyolefin layer directly connected thereto or connected thereto by an adhesive layer, wherein the polyamide is a branched polyamide, and wherein the polyolefin layer consists essentially of polypropylene or of polyethylene, which polyethylene layer, other than adhesive layer, if present, contain only polyethylene which is at least 95% linear low-density polyethylene.

6-7. (Cancelled)

8. (New) Multilayer film according to claim 5, wherein the polyolefin layer consists essentially of linear polypropylene.

9. (New) Multilayer film according to claim 5, wherein the polyolefin layer consists essentially of linear low density polyethylene.

10. (New) Multilayer film according to claim 9, wherein the polyolefin layer includes essentially 0% of another polyethylene characterized by good bubble stability in a blow molding process.

11. (New) Multilayer film according to claim 5, wherein the polyolefin layer consists of linear low density polyethylene alone or in mixture with up to 50 % of modified linear low density polyethylene adhesion modifier, as the only polyolefin material(s).
12. (New) Multilayer film according to claim 5, having a total thickness in the range of from 20 to 300 μm .
13. (New) Multilayer film according to claim 5, wherein the polyolefin layer has a thickness of from 10 μm to about 100 μm .
14. (New) Multilayer film according to claim 13, wherein the polyamide layer has a thickness of from 2 to 150 μm .
15. (New) Multilayer film according to claim 13, wherein the polyamide film as a thickness of at least 20% of the thickness of the polyolefin layer up to 100 μm .
16. (New) A blown film comprising the multilayer film according to claim 5.
17. (New) Blown film according to claim 16, wherein the blown film has a blow-up ratio of from 20 to 40%.
18. (New) Process according to claim 1, wherein the polyolefin layer consists essentially of linear polypropylene.
19. (New) Process according to claim 1, wherein the polyolefin layer consists essentially of linear low density polyethylene.
20. (New) Process according to claim 19, wherein the polyolefin layer includes essentially 0% of another polyethylene characterized by good bubble stability in a blow molding process.

21. (New) Process according to claim 1, wherein the polyolefin layer consists of linear low density polyethylene alone or in mixture with up to 50 % of modified linear low density polyethylene adhesion modifier, as the only polyolefin material(s).
22. (New) Process according to claim 1, wherein the blow-molded multilayer film has a total thickness in the range of from 20 to 300 μm .
23. (New) Process according to claim 1, wherein the polyolefin layer of the blow-molded multilayer film has a thickness of from 10 μm to about 100 μm .
24. (New) Process according to claim 23, wherein the polyamide layer has a thickness of from 2 to 150 μm .
25. (New) Process according to claim 23, wherein the polyamide film has a thickness of at least 20% of the thickness of the polyolefin layer up to 100 μm .